

#### Features

\* Ideal for automated placement

IGD

- \* Low forward voltage drop
- \* Low leakage current
- \* Meets environmental standard MIL-S-19500D
- \* Moisture sensitivity:level 1, per J-STD-020
- \* Solder dip 260°C, 10s





## **Typical Applications**

For use in general purpose rectification of lighting, power supplies, inverters, converters and freewheeling diodes for consumer, automotive and telecommunication.

SMA									
DIM	INC	CHES	MM						
DIN	MIN	MAX	MIN	MAX					
А	0.078	0.090	1.98	2.29					
В	0.052	0.058	1.32	1.47					
С		0.008		0.20					
D	0.030	0.052	0.76	1.32					
E	0.193	0.208	4.90	5.28					
F	0.157	0.177	3.99	4.50					
G	0.006	0.012	0.152	0.305					
Н	0.100	0.110	2.54	2.79					

#### **Mechanical Data**

- \* Case: DO-214AC, molded epoxy body
- \* Epoxy meets UL 94V-0 flammability rating
- \* Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22B-106
- \* Polarity: Laser Band Denotes Cathode Band

Primary Characteristics (TA=25 °C unless otherwise noted)

SYMBOL	VALUE
IF(AV)	1 A
Vrrm	20 V to 100 V
Ігѕм	30A
VF	0.42V,0.5V,0.68V
Tj max.	125 °C ,150°C



#### Maximum Ratings (TA=25 °C unless otherwise noted)

PARAMETER	SYMBOL	SL12	SL13	SL14	SL15	SL16	SL17	SL18	SL19	SL110	UNIT
Maximum repetitive peak reverse voltage	Vrrm	20	30	40	50	60	70	80	90	100	V
Maximum RMS voltage	Vrms	14	21	28	35	42	49	56	63	70	V
Maximum DC blocking voltage	VDC	20	30	40	50	60	70	80	90	100	V
Maximum average forward rectified current at T∟ (See Fig.1)	IF(AV)	1							_	А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	Ігѕм	30								A	
Operating junction temperature range	TJ	- 55 to + 125 - 55 to + 150						°C			
Storage temperature range	Tstg	- 55 to + 150							°C		

#### Electrical Characteristics (TA=25°C unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	SL12	SL13	SL14	SL15	SL16	SL17	SL18	SL19	SL110	UNIT
Maximum instantaneous forward voltage	If=1 A	Vf	0.42		0.5 0.68				V			
Maximum DC reverse	Ta <b>=25</b> ℃	ln.	0.2									mA
blocking voltage	Ta=100℃	IK	10									
Typical junction capacitance	4.0 V, 1 MHz	CJ	85						pF			

#### Thermal Characteristics (TA=25°C unless otherwise noted)

PARAMETER	SYMBOL	SL12	SL13	SL14	SL15	SL16	SL17	SL18	SL19	SL110	UNIT
Maximum thermal	Reja (1)		твр								°C/M
resistance	<b>R</b> θJT (2)	TBD								C/VV	

Notes: (1) Thermal resistance from junction to ambient,0.197×0.197 // (5.0×5.0mm) copper pads to each terminal

(2) Thermal resistance from junction to terminal, 0.197×0.197 // (5.0×5.0mm) copper pads to each terminal



# SL12 THRU SL110 Surface Mount Schottky Barrier Rectifiers

### **Ratings and Characteristic Curves**



Figure 1. Forward Current Derating Curve





Figure 5. Typical Junction Capacitance



Figure 2.Maximum Non-repetitive Peak Forward Surge Current



Figure 4. Typical Reverse Characteristics



## Ordering Information

Part No.	Package	Packing Code	Packing	
SL12 THRU SL110	SMA	R50	5000pcs/Reel	

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